

Case Docket No. MICRON.009DA

Date: July 23, 260 E/VED

In re application of:

Schuegraf et al.

App. No.

08/932,228

Filed

September 17, 1997

For

SHALLOW TRENCH

ISOLATION USING LOW DIELECTRIC CONSTANT

**INSULATOR** 

Examiner

Hung Vu

Art Unit

2811

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on

July 23, 2001

# ASSISTANT COMMISSIONER FOR PATENTS WASHINGTON, D.C. 20231

Sir:

Transmitted herewith is an amendment in the above-identified application.

- A Request for Reconsideration in 5 pages. (X)
- Please charge any additional fees, including any fees for additional extension of time, or credit (X) overpayment to Deposit Account No. 11-1410.
- (X) Return prepaid postcard.

Adeel S. Akhtar

Registration No. 41,394

Attorney of Record

W:\DOCS\ASA\ASA-9646.DOC 072301

MICRON.009D

PATEMEIVED

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE JUL 3 1 2001

Applicant	:	Schuegraf et al.	) Group Art Unit 2811
Appl. No.	:	08/932,228	#-2Z · ·
Filed	:	September 17, 1997	Reg for Reconsiderates
For	:	SHALLOW TRENCH ISOLATION USING LOW DIELECTRIC CONSTANT INSULATOR	FJONES 8-1-01
Examiner	:	Hung Vu	) )

# REQUEST FOR RECONSIDERATION

**Assistant Commissioner for Patents** Washington, D.C. 20231

#### Dear Sir:

In response to the Final Office Action, mailed June 5, 2001, Applicants respectfully request reconsideration of the application in view of the comments below.

### **REMARKS**

The Examiner has continued to reject the claims in view of prior art. Applicants respectfully traverse the rejections and submit that the Examiner is unjustifiably ignoring claim language.

### Rejections Under 35 U.S.C. Section 102 (a)

The Examiner has rejected Claims 21, 22 and 24 as being anticipated by Anjum et al. (U.S. Patent No. 5,372,951). Anjum et al. taught formation of a halide-doped silicon oxide by a thermal oxidation process, or a LoCal Oxidation of Silicon (LOCOS) process. Consequently, the final structure of Anjum et al. is readily recognized as a product of such a process due to the characteristic bird's beak structure inevitably produced by the process of Anjum et al. See Figure 5 of Anjum et al.